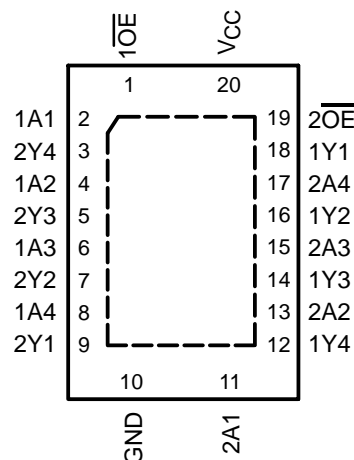


SN74AUCH240 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

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- Optimized for 1.8-V Operation and is 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- I_{off} Supports Partial-Power-Down Mode Operation
- Sub 1-V Operable
- Max t_{pd} of 1.7 ns at 1.8 V
- Low Power Consumption, 20- μ A Max I_{CC}
- ± 8 -mA Output Drive at 1.8 V
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

RGY PACKAGE
(TOP VIEW)



description/ordering information

This octal buffer/driver is operational at 0.8-V to 2.7-V V_{CC} , but is designed specifically for 1.65-V to 1.95-V V_{CC} operation.

The SN74AUCH240 is designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

This device is organized as two 4-bit buffers/drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	QFN – RGY	Tape and reel	SN74AUCH240RGYR	MT240

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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SN74AUCH240

OCTAL BUFFER/DRIVER

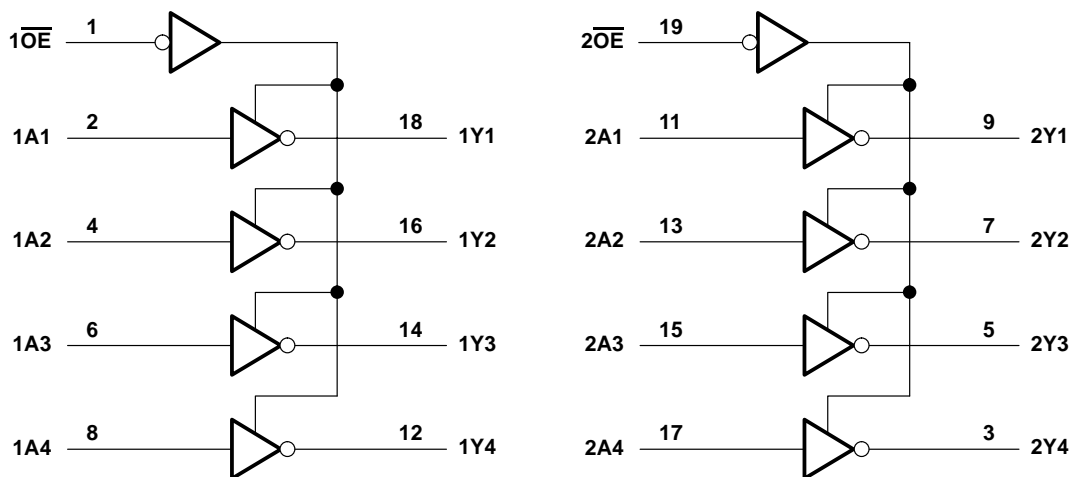
WITH 3-STATE OUTPUTS

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FUNCTION TABLE
(each 4-bit buffer/driver)

INPUTS		OUTPUT
\overline{OE}	A	Y
L	H	L
L	L	H
H	X	Z

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 3.6 V
Input voltage range, V_I (see Note 1)	–0.5 V to 3.6 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 3.6 V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Continuous output current, I_O	±20 mA
Continuous current through V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 2)	37°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-5.

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recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
V _{CC}	Supply voltage	0.8	2.7	V
V _{IH}	High-level input voltage	V _{CC} = 0.8 V	V _{CC}	V
		V _{CC} = 1.1 V to 1.95 V	0.65 × V _{CC}	
		V _{CC} = 2.3 V to 2.7 V	1.7	
V _{IL}	Low-level input voltage	V _{CC} = 0.8 V	0	V
		V _{CC} = 1.1 V to 1.95 V	0.35 × V _{CC}	
		V _{CC} = 2.3 V to 2.7 V	0.7	
V _I	Input voltage	0	3.6	V
V _O	Output voltage	Active state	0 V _{CC}	V
		3-state	0 3.6	
I _{OH}	High-level output current	V _{CC} = 0.8 V	–0.7	mA
		V _{CC} = 1.1 V	–3	
		V _{CC} = 1.4 V	–5	
		V _{CC} = 1.65 V	–8	
		V _{CC} = 2.3 V	–9	
I _{OL}	Low-level output current	V _{CC} = 0.8 V	0.7	mA
		V _{CC} = 1.1 V	3	
		V _{CC} = 1.4 V	5	
		V _{CC} = 1.65 V	8	
		V _{CC} = 2.3 V	9	
Δt/Δv	Input transition rise or fall rate		20	ns/V
T _A	Operating free-air temperature	–40	85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}		I _{OH} = -100 µA	0.8 V to 2.7 V	V _{CC} -0.1			V
		I _{OH} = -0.7 mA	0.8 V	0.55			
		I _{OH} = -3 mA	1.1 V	0.8			
		I _{OH} = -5 mA	1.4 V	1			
		I _{OH} = -8 mA	1.65 V	1.2			
		I _{OH} = -9 mA	2.3 V	1.8			
V _{OL}		I _{OL} = 100 µA	0.8 V to 2.7 V	0.2			V
		I _{OL} = 0.7 mA	0.8 V	0.25			
		I _{OL} = 3 mA	1.1 V	0.3			
		I _{OL} = 5 mA	1.4 V	0.4			
		I _{OL} = 8 mA	1.65 V	0.45			
		I _{OL} = 9 mA	2.3 V	0.6			
I _I	A and $\overline{\text{OE}}$ inputs	V _I = V _{CC} or GND	0 to 2.7 V	±5			µA
I _{BHL} ‡		V _I = 0.35 V	1.1 V	10			µA
		V _I = 0.47 V	1.4 V	15			
		V _I = 0.57 V	1.65 V	20			
		V _I = 0.7 V	2.3 V	40			
I _{BHH} §		V _I = 0.8 V	1.1 V	-10			µA
		V _I = 0.9 V	1.4 V	-15			
		V _I = 1.07 V	1.65 V	-20			
		V _I = 1.7 V	2.3 V	-40			
I _{BHLO} ¶		V _I = 0 to V _{CC}	1.3 V	75			µA
			1.6 V	125			
			1.95 V	175			
			2.7 V	275			
I _{BHHO} #		V _I = 0 to V _{CC}	1.3 V	-75			µA
			1.6 V	-125			
			1.95 V	-175			
			2.7 V	-275			
I _{off}		V _I or V _O = 2.7 V	0	±10			µA
I _{OZ}		V _O = V _{CC} or GND	2.7 V	±10			µA
I _{CC}		V _I = V _{CC} or GND, I _O = 0	0.8 V to 2.7 V	20			µA
C _i		V _I = V _{CC} or GND	2.5 V	3		4	pF
C _o		V _O = V _{CC} or GND	2.5 V	5.5		6	pF

† All typical values are at T_A = 25°C.

‡ The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

§ The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.

¶ An external driver must source at least I_{BHLO} to switch this node from low to high.

An external driver must sink at least I_{BHHO} to switch this node from high to low.



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switching characteristics over recommended operating free-air temperature range, $C_L = 15\text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 0.8\text{ V}$	$V_{CC} = 1.2\text{ V}$ $\pm 0.1\text{ V}$		$V_{CC} = 1.5\text{ V}$ $\pm 0.1\text{ V}$		$V_{CC} = 1.8\text{ V}$ $\pm 0.15\text{ V}$			$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	TYP	MAX	MIN	MAX	
t_{pd}	A	Y	4.8	1.2	3.3	0.8	2	0.7	1.1	1.7	0.6	1.3	ns
t_{en}	\overline{OE}	Y	6.4	1.4	4	0.9	2.6	0.8	1.2	2.1	0.7	1.5	ns
t_{dis}	\overline{OE}	Y	8.7	2	5.8	1.8	3.9	1.8	2.5	4	0.3	3	ns

switching characteristics over recommended operating free-air temperature range, $C_L = 30\text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 1.8\text{ V}$ $\pm 0.15\text{ V}$			$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{pd}	A	Y	1	1.4	2.1	0.9	1.6	ns
t_{en}	\overline{OE}	Y	1.1	1.7	2.7	1	2	ns
t_{dis}	\overline{OE}	Y	1.9	2.5	4	1	2	ns

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CC} = 0.8\text{ V}$	$V_{CC} = 1.2\text{ V}$	$V_{CC} = 1.5\text{ V}$	$V_{CC} = 1.8\text{ V}$	$V_{CC} = 2.5\text{ V}$	UNIT
			TYP	TYP	TYP	TYP	TYP	
C_{pd} Power dissipation capacitance	Outputs enabled	$f = 10\text{ MHz}$	21	21	22	23	27	pF
	Outputs disabled		3	3	3	4	6	

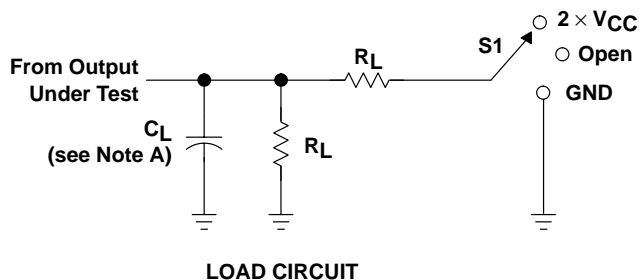
SN74AUCH240

OCTAL BUFFER/DRIVER

WITH 3-STATE OUTPUTS

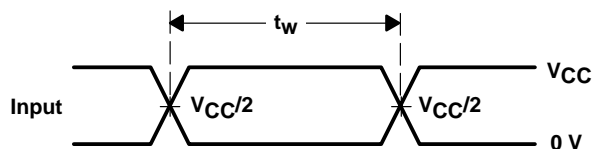
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PARAMETER MEASUREMENT INFORMATION

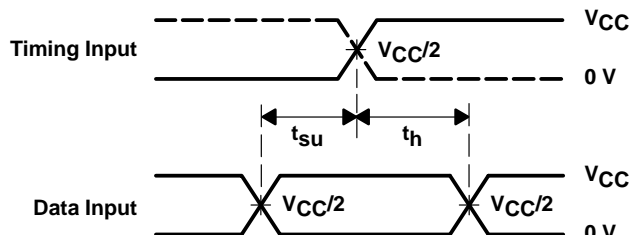


TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND

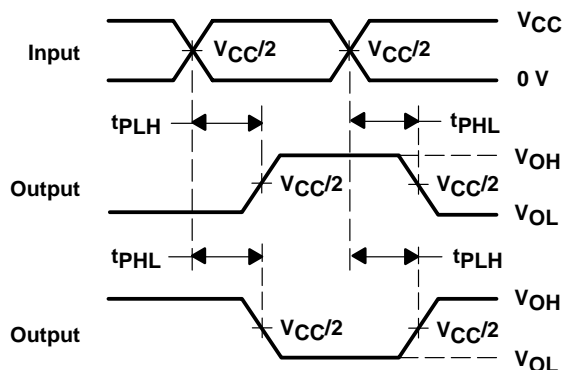
V_{CC}	C_L	R_L	V_{Δ}
0.8 V	15 pF	2 k Ω	0.1 V
1.2 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.5 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.8 V \pm 0.15 V	15 pF	2 k Ω	0.15 V
2.5 V \pm 0.2 V	15 pF	2 k Ω	0.15 V
1.8 V \pm 0.15 V	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	30 pF	500 Ω	0.15 V



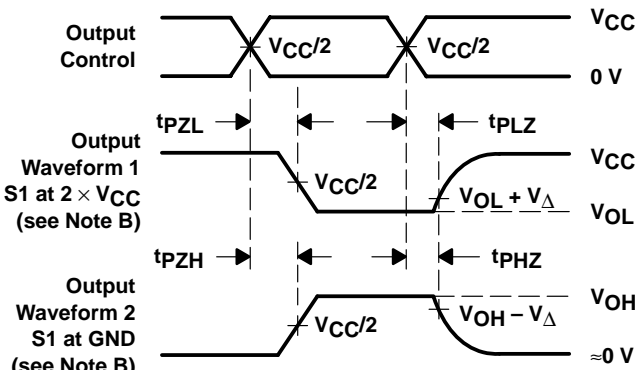
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

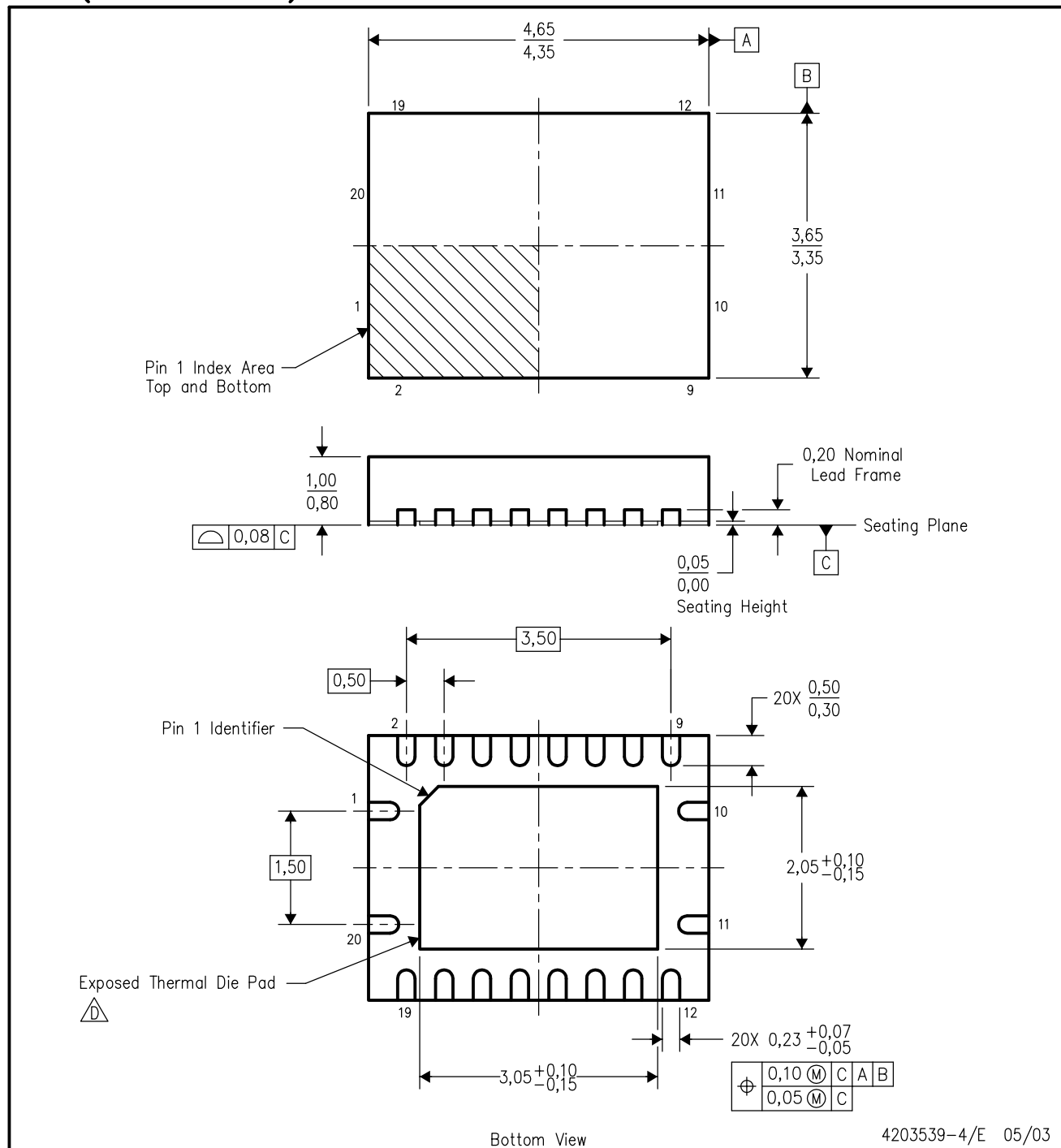
- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, slew rate $\geq 1 \text{ V/ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .
 - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



RGY (R-PQFP-N20)

PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 - The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
 - E. Package complies to JEDEC MO-241 variation BC.

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